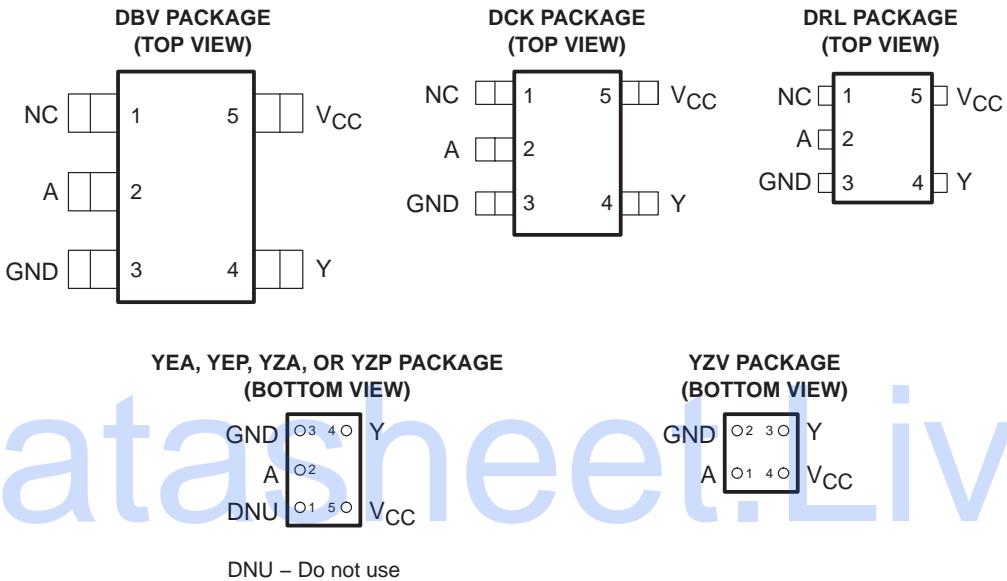


- Available in the Texas Instruments NanoStar™ and NanoFree™ Packages
- Supports 5-V V_{CC} Operation
- Inputs Accept Voltages to 5.5 V
- Max t_{pd} of 4.6 ns at 3.3 V
- Low Power Consumption, 10- μ A Max I_{CC}
- ± 24 -mA Output Drive at 3.3 V
- I_{off} Supports Partial-Power-Down Mode Operation
- Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II
- ESD Protection Exceeds JESD 22
 - 2000-V Human-Body Model (A114-A)
 - 200-V Machine Model (A115-A)
 - 1000-V Charged-Device Model (C101)



DNU – Do not use

See mechanical drawings for dimensions.

description/ordering information

This single Schmitt-trigger buffer is designed for 1.65-V to 5.5-V V_{CC} operation.

The SN74LVC1G17 contains one buffer and performs the Boolean function Y = A. The device functions as an independent buffer, but because of Schmitt action, it may have different input threshold levels for positive-going (V_{T+}) and negative-going (V_{T-}) signals.

NanoStar™ and NanoFree™ package technology is a major breakthrough in IC packaging concepts, using the die as the package.

This device is fully specified for partial-power-down applications using I_{off}. The I_{off} circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

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PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

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SN74LVC1G17

SINGLE SCHMITT-TRIGGER BUFFER

SCES351N – JUNE 2001 – REVISED OCTOBER 2005

ORDERING INFORMATION

| TA | PACKAGE [†] | ORDERABLE PART NUMBER | TOP-SIDE MARKING [‡] |
|---------------|--|-----------------------|-------------------------------|
| -40°C to 85°C | NanoStar™ – WCSP (DSBGA) 0.17-mm Small Bump – YEA | Reel of 3000 | C7_ |
| | NanoFree™ – WCSP (DSBGA) 0.17-mm Small Bump – YZA (Pb-free) | | |
| | NanoStar™ – WCSP (DSBGA) 0.23-mm Large Bump – YEP | | |
| | NanoFree™ – WCSP (DSBGA) 0.23-mm Large Bump – YZP (Pb-free) | | |
| | NanoFree™ – WCSP (DSBGA) 0.23-mm Large Bump – YZV (Pb-free) | Reel of 3000 | --- C7 |
| | SOT (SOT-23) – DBV | Reel of 3000 | C17_ |
| | | Reel of 250 | |
| | SOT (SC-70) – DCK | Reel of 3000 | C7_ |
| | | Reel of 250 | |
| | SOT (SOT-553) – DRL | Reel of 4000 | C7_ |

[†] Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

[‡] DBV/DCK/DRL: The actual top-side marking has one additional character that designates the assembly/test site.

YEA/YEP, YZA/YZP: The actual top-side marking has three preceding characters to denote year, month, and sequence code, and one following character to designate the assembly/test site. Pin 1 identifier indicates solder-bump composition (1 = SnPb, • = Pb-free).

YZV: The actual top-side marking is on two lines. Line 1 has four characters to denote year, month, day, and assembly/test site. Line 2 has two characters which show the family and function code. Pin 1 identifier indicates solder-bump composition (1 = SnPb, • = Pb-free).

FUNCTION TABLE

| INPUT A | OUTPUT Y |
|---------|----------|
| H | H |
| L | L |

logic diagram (positive logic) (DBV, DCK, DRL, YEA, YEP, YZA, and YZP Package)



logic diagram (positive logic) (YZV Package)



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

| | | |
|---|-----------------|----------------------------|
| Supply voltage range, V_{CC} | | -0.5 V to 6.5 V |
| Input voltage range, V_I (see Note 1) | | -0.5 V to 6.5 V |
| Voltage range applied to any output in the high-impedance or power-off state, V_O (see Note 1) | | -0.5 V to 6.5 V |
| Voltage range applied to any output in the high or low state, V_O (see Notes 1 and 2) | | -0.5 V to $V_{CC} + 0.5$ V |
| Input clamp current, I_{IK} ($V_I < 0$) | | -50 mA |
| Output clamp current, I_{OK} ($V_O < 0$) | | -50 mA |
| Continuous output current, I_O | | ± 50 mA |
| Continuous current through V_{CC} or GND | | ± 100 mA |
| Package thermal impedance, θ_{JA} (see Note 3): | DBV package | 206°C/W |
| | DCK package | 252°C/W |
| | DRL package | 142°C/W |
| | YEA/YZA package | 154°C/W |
| | YPE/YZP package | 132°C/W |
| | YZV package | 116°C/W |
| Storage temperature range, T_{stg} | | -65°C to 150°C |

† Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES:** 1. The input and output negative-voltage ratings may be exceeded if the input and output current ratings are observed.
2. The value of V_{CC} is provided in the recommended operating conditions table.
3. The package thermal impedance is calculated in accordance with JESD 51-7.

recommended operating conditions (see Note 4)

| | | | MIN | MAX | UNIT |
|-----------------|--------------------------------|---------------------|--------------------------|-----------------|------|
| V _{CC} | Supply voltage | Operating | 1.65 | 5.5 | V |
| | | Data retention only | 1.5 | | |
| V _I | Input voltage | | 0 | 5.5 | V |
| V _O | Output voltage | | 0 | V _{CC} | V |
| I _{OH} | High-level output current | | V _{CC} = 1.65 V | -4 | mA |
| | | | V _{CC} = 2.3 V | -8 | |
| | | | V _{CC} = 3 V | -16 | |
| | | | | -24 | |
| | | | V _{CC} = 4.5 V | -32 | |
| I _{OL} | Low-level output current | | V _{CC} = 1.65 V | 4 | mA |
| | | | V _{CC} = 2.3 V | 8 | |
| | | | V _{CC} = 3 V | 16 | |
| | | | | 24 | |
| | | | V _{CC} = 4.5 V | 32 | |
| T _A | Operating free-air temperature | | -40 | 85 | °C |

NOTE 4: All unused inputs of the device must be held at VCC or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

SN74LVC1G17

SINGLE SCHMITT-TRIGGER BUFFER

SCES351N – JUNE 2001 – REVISED OCTOBER 2005

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER | TEST CONDITIONS | | V _{CC} | MIN | TYP† | MAX | UNIT |
|---|---------------------------|--|-----------------|-----------------------|------|-----|------|
| V _{T+} Positive-going input threshold voltage | | | 1.65 V | 0.76 | 1.13 | | V |
| | | | 2.3 V | 1.08 | 1.56 | | |
| | | | 3 V | 1.48 | 1.92 | | |
| | | | 4.5 V | 2.19 | 2.74 | | |
| | | | 5.5 V | 2.65 | 3.33 | | |
| V _{T-} Negative-going input threshold voltage | | | 1.65 V | 0.35 | 0.59 | | V |
| | | | 2.3 V | 0.56 | 0.88 | | |
| | | | 3 V | 0.89 | 1.2 | | |
| | | | 4.5 V | 1.51 | 1.97 | | |
| | | | 5.5 V | 1.88 | 2.4 | | |
| ΔV _T Hysteresis (V _{T+} – V _{T-}) | | | 1.65 V | 0.36 | 0.64 | | V |
| | | | 2.3 V | 0.45 | 0.78 | | |
| | | | 3 V | 0.51 | 0.83 | | |
| | | | 4.5 V | 0.58 | 0.93 | | |
| | | | 5.5 V | 0.69 | 1.04 | | |
| V _{OH} | I _{OH} = -100 μA | | 1.65 V to 4.5 V | V _{CC} – 0.1 | | | V |
| | I _{OH} = -4 mA | | 1.65 V | 1.2 | | | |
| | I _{OH} = -8 mA | | 2.3 V | 1.9 | | | |
| | I _{OH} = -16 mA | | | 2.4 | | | |
| | I _{OH} = -24 mA | | 3 V | | 2.3 | | |
| | I _{OH} = -32 mA | | 4.5 V | 3.8 | | | |
| V _{OL} | I _{OL} = 100 μA | | 1.65 V to 4.5 V | | 0.1 | | V |
| | I _{OL} = 4 mA | | 1.65 V | | 0.45 | | |
| | I _{OL} = 8 mA | | 2.3 V | | 0.3 | | |
| | I _{OL} = 16 mA | | | 0.4 | | | |
| | I _{OL} = 24 mA | | 3 V | | 0.55 | | |
| | I _{OL} = 32 mA | | 4.5 V | | 0.55 | | |
| I _I | A input | V _I = 5.5 V or GND | 0 to 5.5 V | | ±5 | μA | |
| I _{off} | | V _I or V _O = 5.5 V | 0 | | ±10 | μA | |
| I _{CC} | | V _I = 5.5 V or GND, I _O = 0 | 1.65 V to 5.5 V | | 10 | μA | |
| ΔI _{CC} | | One input at V _{CC} – 0.6 V, Other inputs at V _{CC} or GND | 3 V to 5.5 V | | 500 | μA | |
| C _i | | V _I = V _{CC} or GND | 3.3 V | | 4.5 | pF | |

† All typical values are at V_{CC} = 3.3 V, T_A = 25°C.

switching characteristics over recommended operating free-air temperature range, C_L = 15 pF (unless otherwise noted) (see Figure 1)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | V _{CC} = 1.8 V ± 0.15 V | V _{CC} = 2.5 V ± 0.2 V | V _{CC} = 3.3 V ± 0.3 V | V _{CC} = 5 V ± 0.5 V | UNIT |
|-----------------|-----------------|----------------|-------------------------------------|------------------------------------|------------------------------------|----------------------------------|--------------------|
| | | | MIN | MAX | MIN | MAX | |
| t _{pd} | A | Y | 2.8 | 9.9 | 1.6 | 5.5 | 1.5 4.6 0.9 4.4 ns |

SN74LVC1G17
SINGLE SCHMITT-TRIGGER BUFFER

SCES351N – JUNE 2001 – REVISED OCTOBER 2005

switching characteristics over recommended operating free-air temperature range, $C_L = 30 \text{ pF}$ or 50 pF (unless otherwise noted) (see Figure 2)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | $V_{CC} = 1.8 \text{ V} \pm 0.15 \text{ V}$ | | $V_{CC} = 2.5 \text{ V} \pm 0.2 \text{ V}$ | | $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$ | | $V_{CC} = 5 \text{ V} \pm 0.5 \text{ V}$ | | |
|-----------|-----------------|----------------|---|-----|--|-----|--|-----|--|-----|----|
| | | | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | |
| t_{pd} | A | Y | 3.8 | 11 | 2 | 6.5 | 1.8 | 5.5 | 1.2 | 5 | ns |

operating characteristics, $T_A = 25^\circ\text{C}$

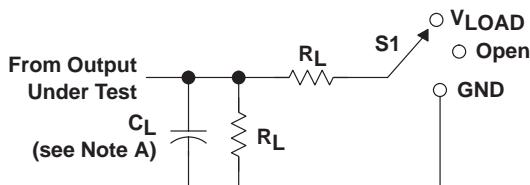
| PARAMETER | TEST CONDITIONS | $V_{CC} = 1.8 \text{ V}$ | | $V_{CC} = 2.5 \text{ V}$ | | $V_{CC} = 3.3 \text{ V}$ | | $V_{CC} = 5 \text{ V}$ | | UNIT |
|--|----------------------|--------------------------|----|--------------------------|----|--------------------------|----|------------------------|----|------|
| | | TYP | | TYP | | TYP | | TYP | | |
| C_{pd} Power dissipation capacitance | $f = 10 \text{ MHz}$ | | 20 | | 21 | | 22 | | 26 | pF |

SN74LVC1G17

SINGLE SCHMITT-TRIGGER BUFFER

SCES351N – JUNE 2001 – REVISED OCTOBER 2005

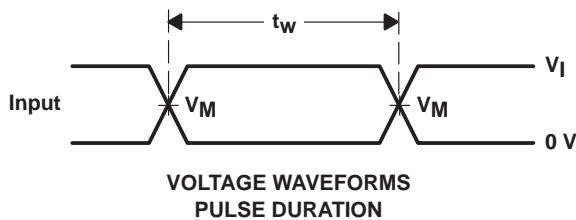
PARAMETER MEASUREMENT INFORMATION



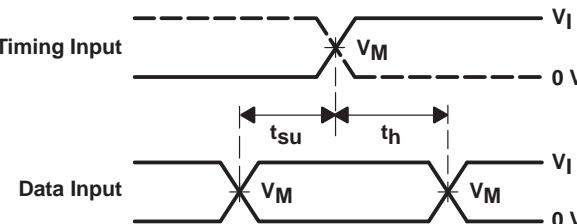
| TEST | S1 |
|-------------------|------------|
| t_{PLH}/t_{PHL} | Open |
| t_{PLZ}/t_{PZL} | V_{LOAD} |
| t_{PHZ}/t_{PZH} | GND |

LOAD CIRCUIT

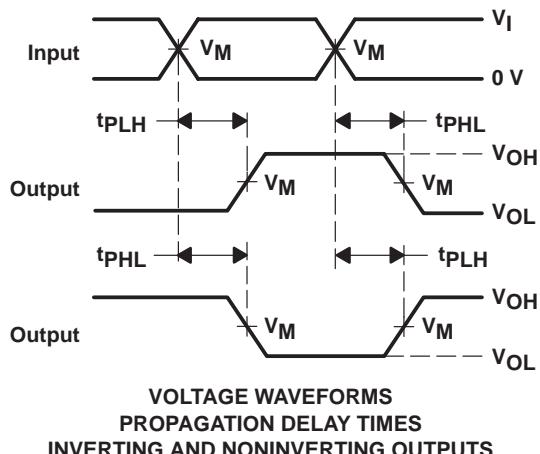
| V_{CC} | INPUTS | | V_M | V_{LOAD} | C_L | R_L | V_Δ |
|--------------------|----------|---------------|------------|-------------------|-------|-------------|------------|
| | V_I | t_r/t_f | | | | | |
| $1.8 V \pm 0.15 V$ | V_{CC} | ≤ 2 ns | $V_{CC}/2$ | $2 \times V_{CC}$ | 15 pF | $1 M\Omega$ | 0.15 V |
| $2.5 V \pm 0.2 V$ | V_{CC} | ≤ 2 ns | $V_{CC}/2$ | $2 \times V_{CC}$ | 15 pF | $1 M\Omega$ | 0.15 V |
| $3.3 V \pm 0.3 V$ | 3 V | ≤ 2.5 ns | 1.5 V | 6 V | 15 pF | $1 M\Omega$ | 0.3 V |
| $5 V \pm 0.5 V$ | V_{CC} | ≤ 2.5 ns | $V_{CC}/2$ | $2 \times V_{CC}$ | 15 pF | $1 M\Omega$ | 0.3 V |



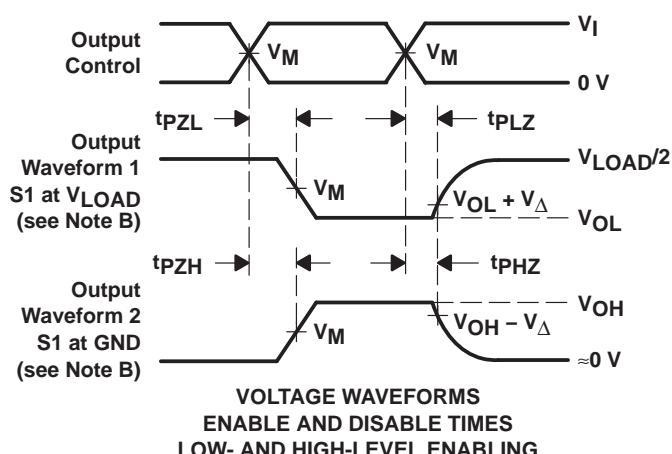
VOLTAGE WAVEFORMS
PULSE DURATION



VOLTAGE WAVEFORMS
SETUP AND HOLD TIMES



VOLTAGE WAVEFORMS
PROPAGATION DELAY TIMES
INVERTING AND NONINVERTING OUTPUTS



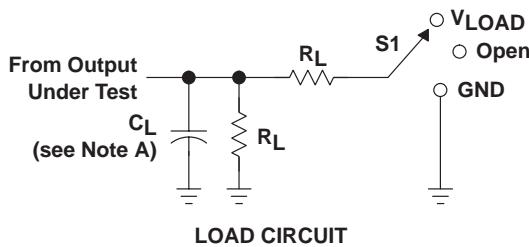
VOLTAGE WAVEFORMS
ENABLE AND DISABLE TIMES
LOW- AND HIGH-LEVEL ENABLING

NOTES: A. C_L includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR ≤ 10 MHz, $Z_O = 50 \Omega$.
- D. The outputs are measured one at a time, with one transition per measurement.
- E. t_{PLZ} and t_{PHZ} are the same as t_{dis} .
- F. t_{PZL} and t_{PZH} are the same as t_{en} .
- G. t_{PLH} and t_{PHL} are the same as t_{pd} .
- H. All parameters and waveforms are not applicable to all devices.

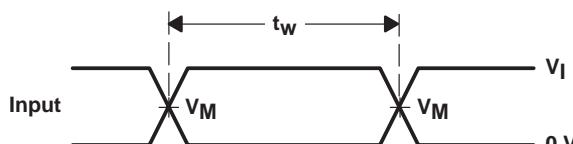
Figure 1. Load Circuit and Voltage Waveforms

PARAMETER MEASUREMENT INFORMATION

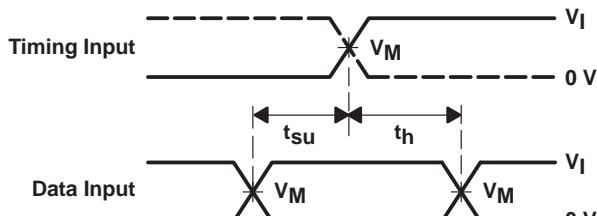


| TEST | S1 |
|-------------------|------------|
| t_{PLH}/t_{PHL} | Open |
| t_{PLZ}/t_{PZL} | V_{LOAD} |
| t_{PHZ}/t_{PZH} | GND |

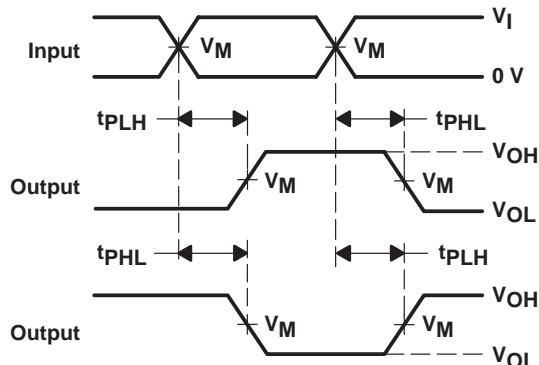
| V_{CC} | INPUTS | | V_M | V_{LOAD} | C_L | R_L | V_Δ |
|------------------------------------|----------|-----------------------|------------|-------------------|-------|--------------|------------|
| | V_I | t_r/t_f | | | | | |
| $1.8 \text{ V} \pm 0.15 \text{ V}$ | V_{CC} | $\leq 2 \text{ ns}$ | $V_{CC}/2$ | $2 \times V_{CC}$ | 30 pF | 1 k Ω | 0.15 V |
| $2.5 \text{ V} \pm 0.2 \text{ V}$ | V_{CC} | $\leq 2 \text{ ns}$ | $V_{CC}/2$ | $2 \times V_{CC}$ | 30 pF | 500 Ω | 0.15 V |
| $3.3 \text{ V} \pm 0.3 \text{ V}$ | 3 V | $\leq 2.5 \text{ ns}$ | 1.5 V | 6 V | 50 pF | 500 Ω | 0.3 V |
| $5 \text{ V} \pm 0.5 \text{ V}$ | V_{CC} | $\leq 2.5 \text{ ns}$ | $V_{CC}/2$ | $2 \times V_{CC}$ | 50 pF | 500 Ω | 0.3 V |



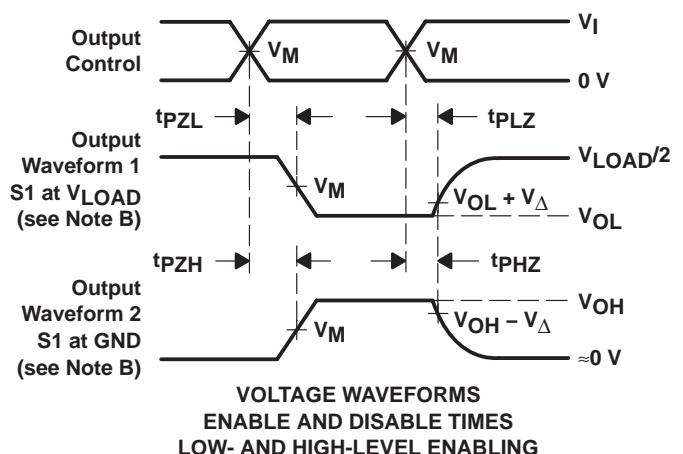
VOLTAGE WAVEFORMS
PULSE DURATION



VOLTAGE WAVEFORMS
SETUP AND HOLD TIMES



VOLTAGE WAVEFORMS
PROPAGATION DELAY TIMES
INVERTING AND NONINVERTING OUTPUTS



VOLTAGE WAVEFORMS
ENABLE AND DISABLE TIMES
LOW- AND HIGH-LEVEL ENABLING

- NOTES:
- A. C_L includes probe and jig capacitance.
 - B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
 - C. All input pulses are supplied by generators having the following characteristics: PRR $\leq 10 \text{ MHz}$, $Z_O = 50 \Omega$.
 - D. The outputs are measured one at a time, with one transition per measurement.
 - E. t_{PLZ} and t_{PHZ} are the same as t_{dis} .
 - F. t_{PZL} and t_{PZH} are the same as t_{en} .
 - G. t_{PLH} and t_{PHL} are the same as t_{pd} .
 - H. All parameters and waveforms are not applicable to all devices.

Figure 2. Load Circuit and Voltage Waveforms

PACKAGING INFORMATION

| Orderable Device | Status ⁽¹⁾ | Package Type | Package Drawing | Pins | Package Qty | Eco Plan ⁽²⁾ | Lead/Ball Finish | MSL Peak Temp ⁽³⁾ |
|-------------------|-----------------------|--------------|-----------------|------|-------------|-------------------------|------------------|------------------------------|
| SN74LVC1G17DBVR | ACTIVE | SOT-23 | DBV | 5 | 3000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LVC1G17DBVRE4 | ACTIVE | SOT-23 | DBV | 5 | 3000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LVC1G17DBVRG4 | ACTIVE | SOT-23 | DBV | 5 | 3000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LVC1G17DBVT | ACTIVE | SOT-23 | DBV | 5 | 250 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LVC1G17DBVTE4 | ACTIVE | SOT-23 | DBV | 5 | 250 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LVC1G17DCKR | ACTIVE | SC70 | DCK | 5 | 3000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LVC1G17DCKRE4 | ACTIVE | SC70 | DCK | 5 | 3000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LVC1G17DCKRG4 | ACTIVE | SC70 | DCK | 5 | 3000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LVC1G17DCKT | ACTIVE | SC70 | DCK | 5 | 250 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LVC1G17DCKTE4 | ACTIVE | SC70 | DCK | 5 | 250 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LVC1G17DRLR | ACTIVE | SOP | DRL | 5 | 4000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LVC1G17DRLRG4 | ACTIVE | SOP | DRL | 5 | 4000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LVC1G17YEAR | ACTIVE | WCSP | YEA | 5 | 3000 | TBD | SNPB | Level-1-260C-UNLIM |
| SN74LVC1G17YEPR | ACTIVE | WCSP | YEP | 5 | 3000 | TBD | SNPB | Level-1-260C-UNLIM |
| SN74LVC1G17YZAR | ACTIVE | WCSP | YZA | 5 | 3000 | Pb-Free (RoHS) | SNAGCU | Level-1-260C-UNLIM |
| SN74LVC1G17YZPR | ACTIVE | WCSP | YZP | 5 | 3000 | Pb-Free (RoHS) | SNAGCU | Level-1-260C-UNLIM |

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

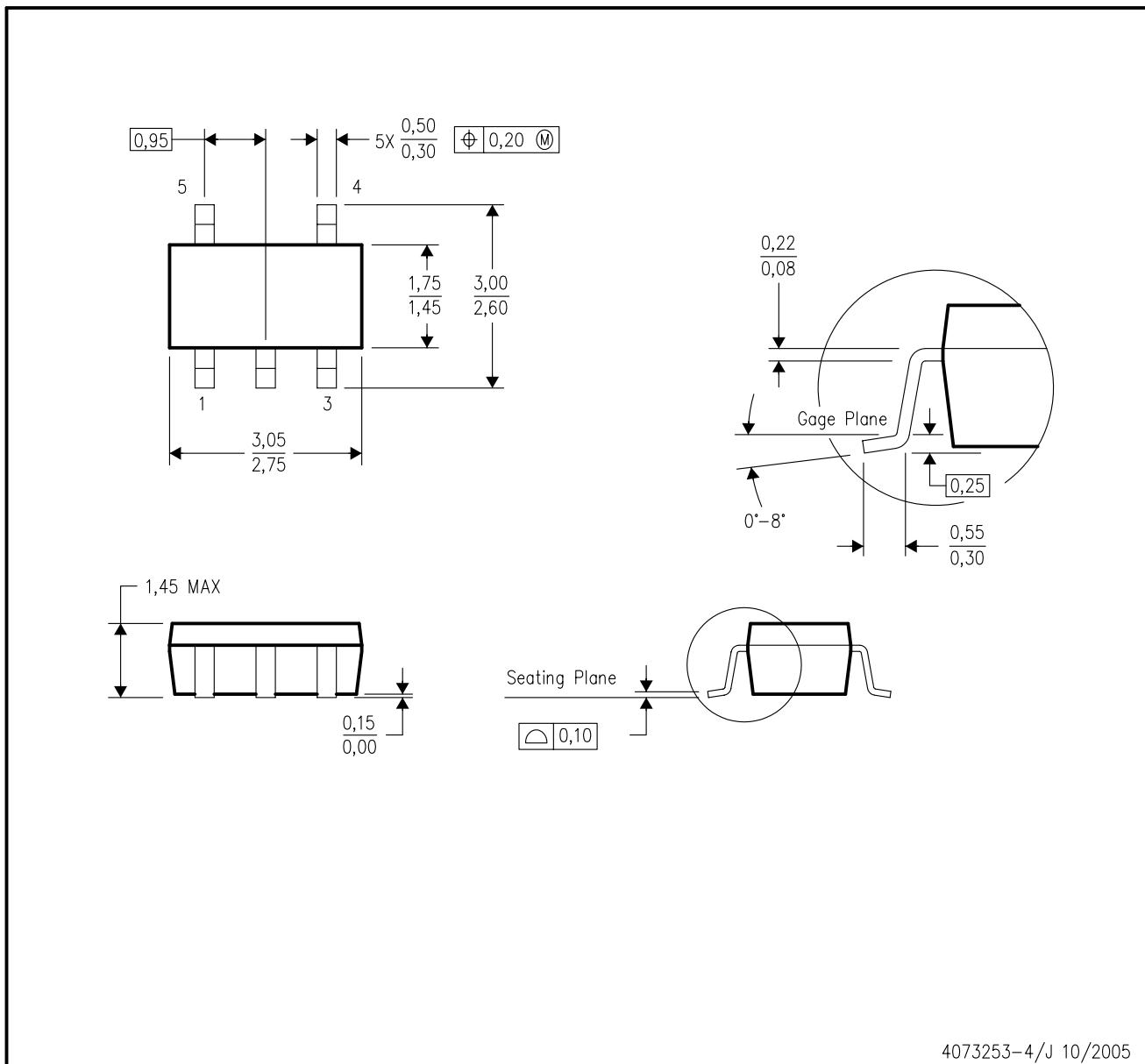
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DBV (R-PDSO-G5)

PLASTIC SMALL-OUTLINE PACKAGE

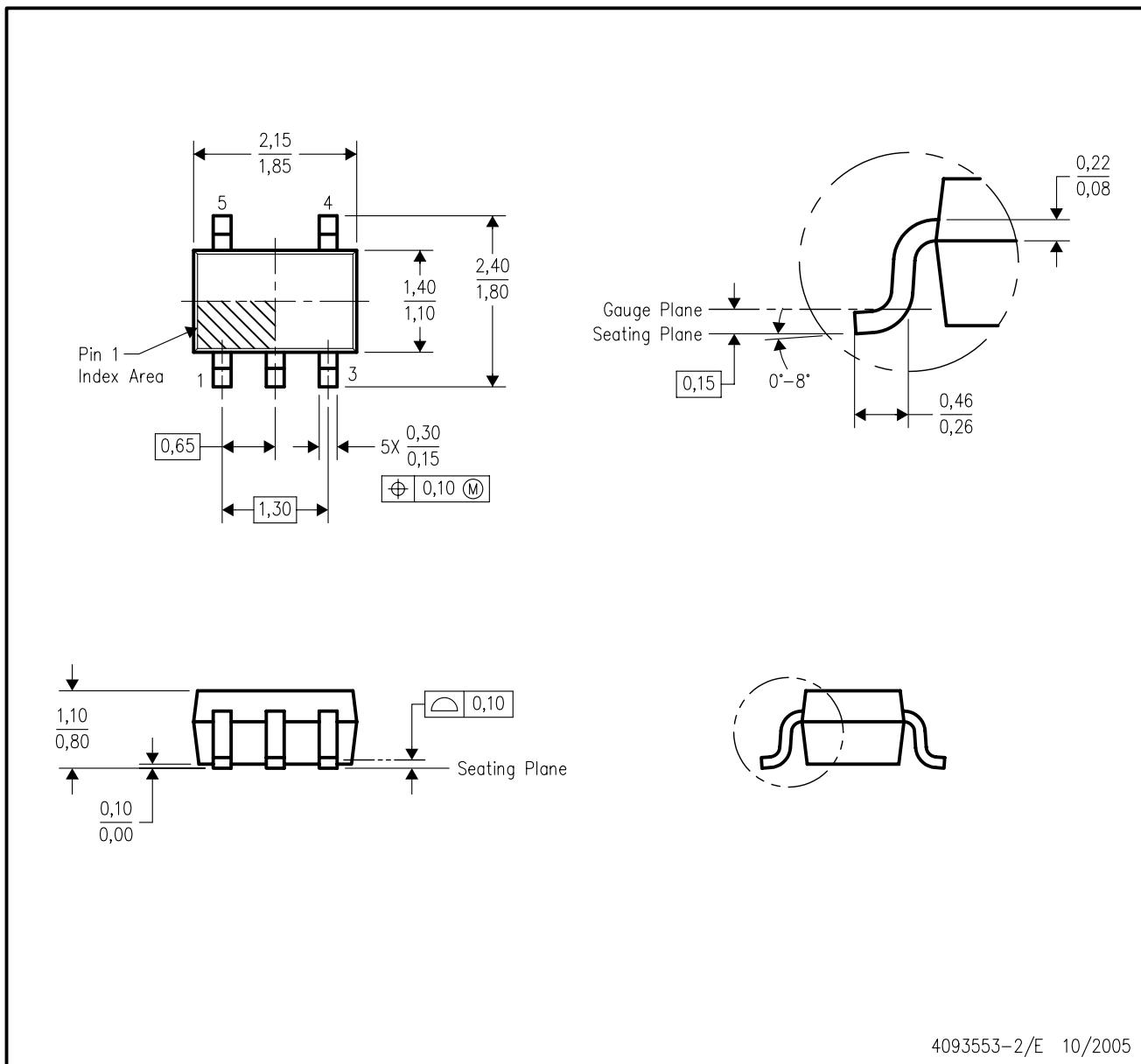


4073253-4/J 10/2005

- NOTES:
- All linear dimensions are in millimeters.
 - This drawing is subject to change without notice.
 - Body dimensions do not include mold flash or protrusion. Mold flash and protrusion shall not exceed 0.15 per side.
 - Falls within JEDEC MO-178 Variation AA.

DCK (R-PDSO-G5)

PLASTIC SMALL-OUTLINE PACKAGE

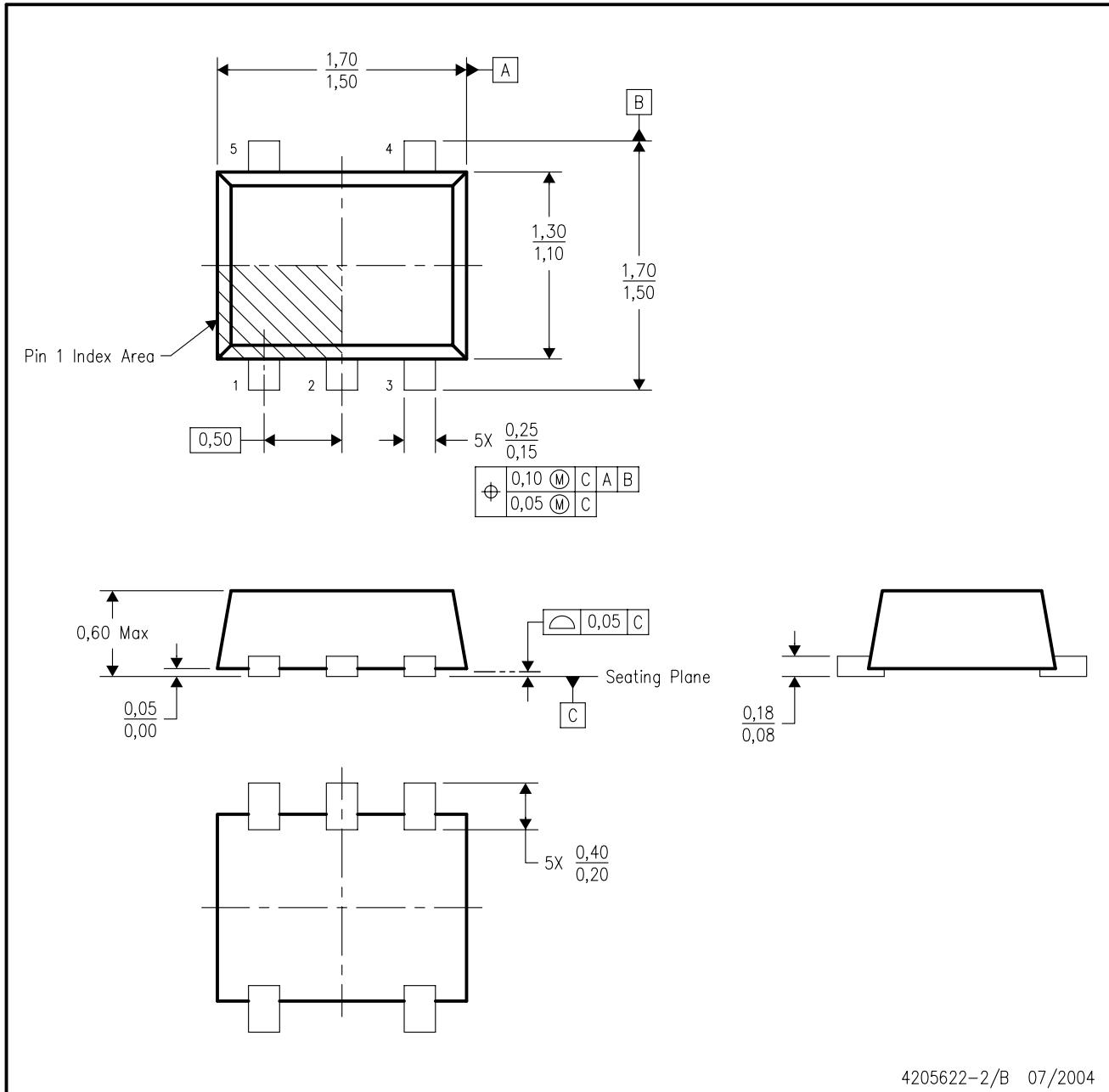


4093553-2/E 10/2005

- NOTES:
- All linear dimensions are in millimeters.
 - This drawing is subject to change without notice.
 - Body dimensions do not include mold flash or protrusion. Mold flash and protrusion shall not exceed 0.15 per side.
 - Falls within JEDEC MO-203 variation AA.

DRL (R-PDSO-N5)

PLASTIC SMALL OUTLINE

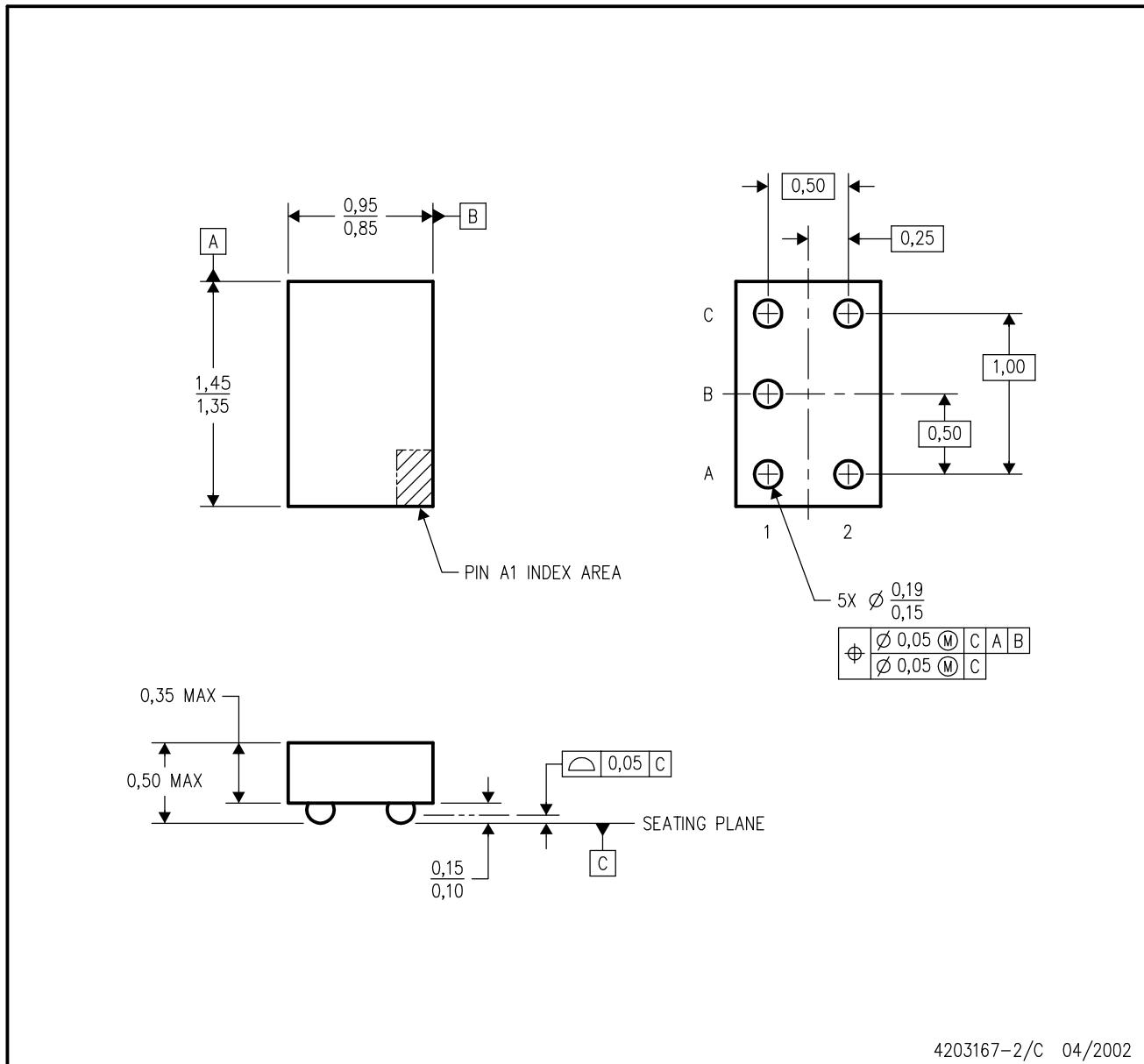


4205622-2/B 07/2004

- NOTES:
- All linear dimensions are in millimeters.
 - This drawing is subject to change without notice.
 - JEDEC package registration is pending.

YEA (R-XBGA-N5)

DIE-SIZE BALL GRID ARRAY



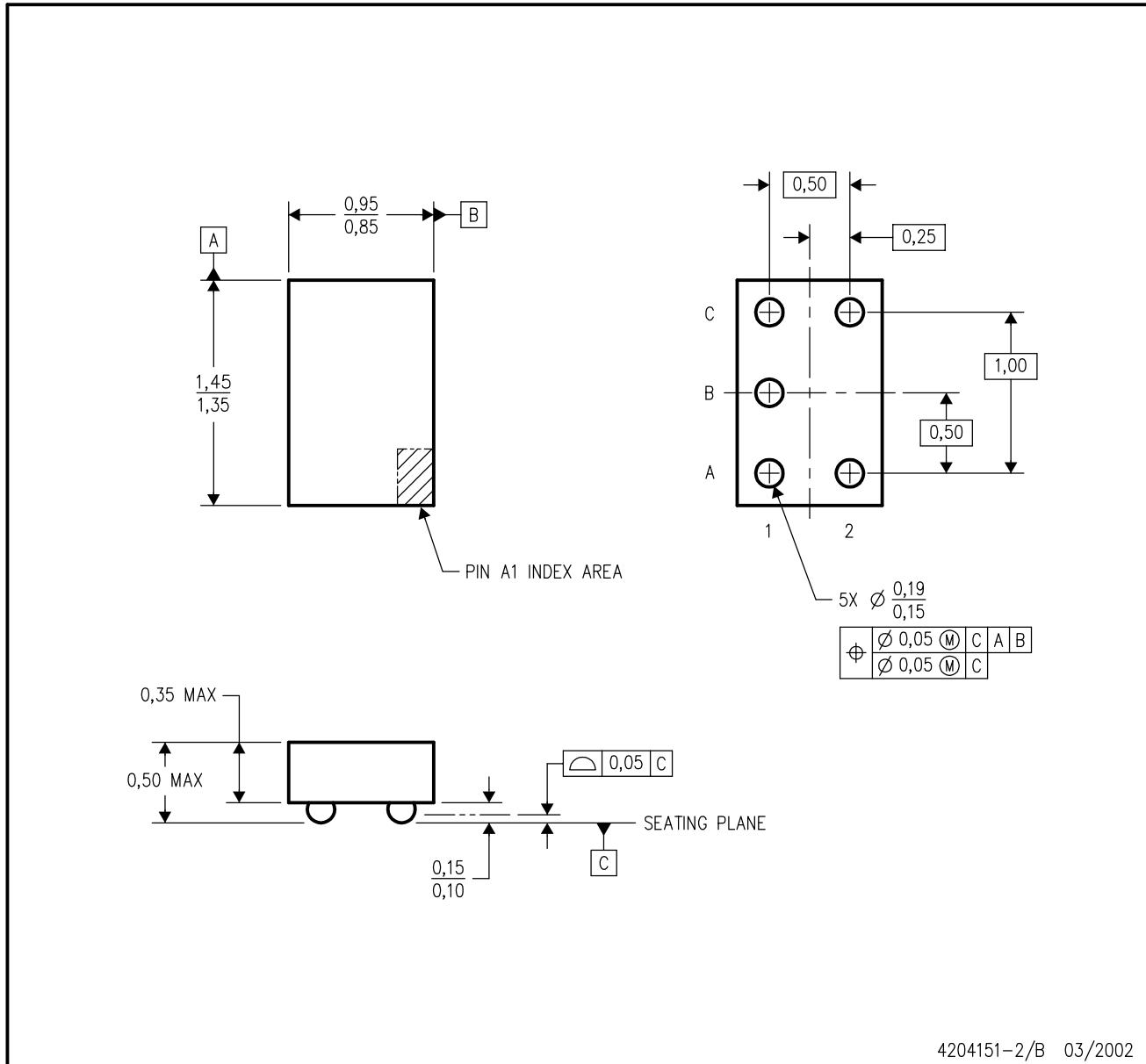
4203167-2/C 04/2002

- NOTES:
- All linear dimensions are in millimeters.
 - This drawing is subject to change without notice.
 - NanoStar™ package configuration.
 - Package complies to JEDEC MO-211 variation EA.
 - This package is tin-lead (SnPb). Refer to the 5 YZA package (drawing 4204151) for lead-free.

NanoStar is a trademark of Texas Instruments.

YZA (R-XBGA-N5)

DIE-SIZE BALL GRID ARRAY



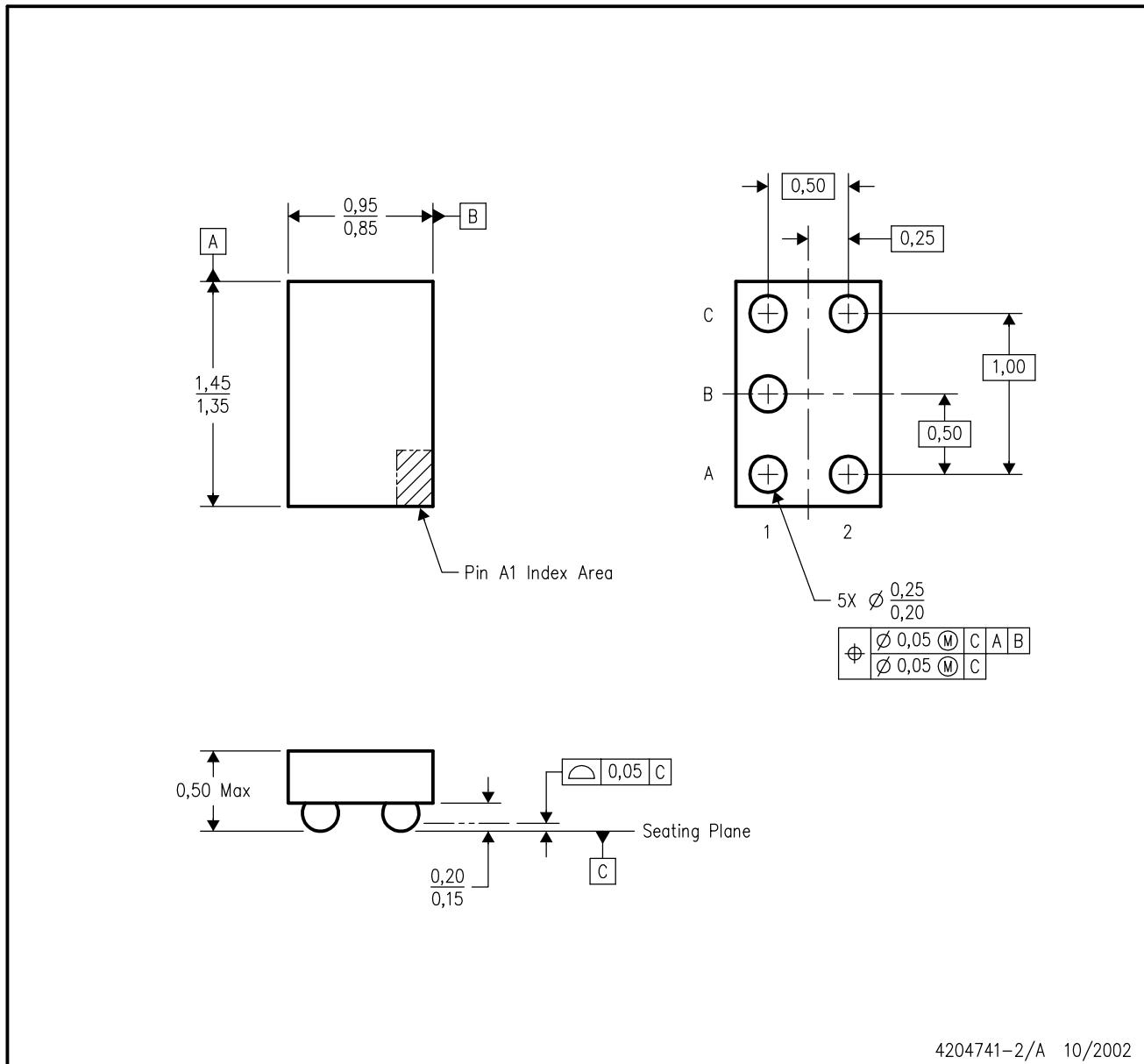
4204151-2/B 03/2002

- NOTES:
- All linear dimensions are in millimeters.
 - This drawing is subject to change without notice.
 - NanoFree™ package configuration.
 - Package complies to JEDEC MO-211 variation EA.
 - This package is lead-free. Refer to the 5 YEA package (drawing 4203167) for tin-lead (SnPb).

NanoFree is a trademark of Texas Instruments.

YZP (R-XBGA-N5)

DIE-SIZE BALL GRID ARRAY



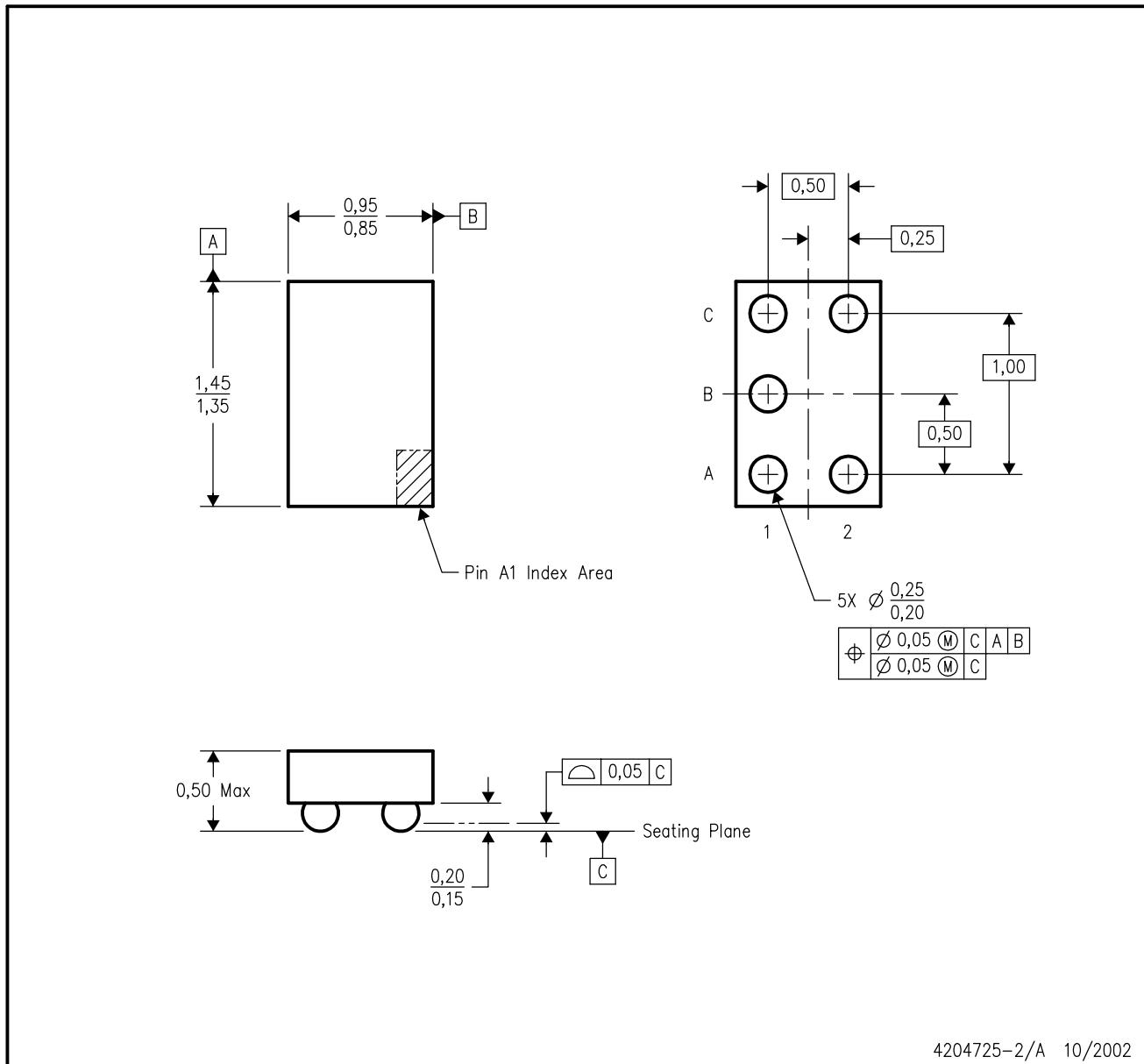
4204741-2/A 10/2002

- NOTES:
- All linear dimensions are in millimeters.
 - This drawing is subject to change without notice.
 - NanoFree™ package configuration.
 - This package is lead-free. Refer to the 5 YEP package (drawing 4204725) for tin-lead (SnPb).

NanoFree is a trademark of Texas Instruments.

YEP (R-XBGA-N5)

DIE-SIZE BALL GRID ARRAY



4204725-2/A 10/2002

- NOTES:
- All linear dimensions are in millimeters.
 - This drawing is subject to change without notice.
 - NanoStar™ package configuration.
 - This package is tin-lead (SnPb). Refer to the 5 YZP package (drawing 4204741) for lead-free.

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the die as the package.

This device is fully specified for partial-power-down applications using I_{off}. The I_{off} circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.

Pricing/Packaging/CAD Design Tools/Samples

| | | | Price | Packaging | | | CAD Design Tools | Samples |
|-------------------|--------|-----------|---------------------------|-----------------------------------|----------------------|------------------------|--------------------------|--------------------------------------|
| Device | Status | Temp (°C) | Budget Price (\$US) QTY | Industry Standard (TI Pkg) Pins | Top Side Marking | Standard Pack Quantity | Footprints | Samples |
| SN74LVC1G17DBVR | ACTIVE | -40 to 85 | 0.12 1KU | SOT-23 (DBV) 5 | View | 3000 | <input type="checkbox"/> | Request Free Samples |
| SN74LVC1G17DBVRE4 | ACTIVE | -40 to 85 | 0.13 1KU | SOT-23 (DBV) 5 | View | 3000 | <input type="checkbox"/> | Purchase Samples |
| SN74LVC1G17DBVRG4 | ACTIVE | | 0.13 1KU | SOT-23 (DBV) 5 | View | 3000 | <input type="checkbox"/> | Purchase Samples |
| SN74LVC1G17DBVT | ACTIVE | -40 to 85 | 0.46 1KU | SOT-23 (DBV) 5 | View | 250 | <input type="checkbox"/> | Purchase Samples |
| SN74LVC1G17DBVTE4 | ACTIVE | -40 to 85 | 0.46 1KU | SOT-23 (DBV) 5 | View | 250 | <input type="checkbox"/> | Purchase Samples |
| SN74LVC1G17DCKR | ACTIVE | -40 to 85 | 0.13 1KU | SC70 (DCK) 5 | View | 3000 | <input type="checkbox"/> | Request Free Samples |
| SN74LVC1G17DCKRE4 | ACTIVE | -40 to 85 | 0.13 1KU | SC70 (DCK) 5 | View | 3000 | <input type="checkbox"/> | Request Free Samples |
| SN74LVC1G17DCKRG4 | ACTIVE | -40 to 85 | 0.15 1KU | SC70 (DCK) 5 | View | 3000 | <input type="checkbox"/> | Purchase Samples |
| SN74LVC1G17DCKT | ACTIVE | -40 to 85 | 0.46 1KU | SC70 (DCK) 5 | View | 250 | <input type="checkbox"/> | Purchase Samples |
| SN74LVC1G17DCKTE4 | ACTIVE | -40 to 85 | 0.46 1KU | SC70 (DCK) 5 | View | 250 | <input type="checkbox"/> | Purchase Samples |
| SN74LVC1G17DRLR | ACTIVE | -40 to 85 | 0.13 1KU | SOP (DRL) 5 | | 4000 | <input type="checkbox"/> | Request Free Samples |
| SN74LVC1G17DRLRG4 | ACTIVE | -40 to 85 | 0.13 1KU | SOP (DRL) 5 | | 4000 | <input type="checkbox"/> | Request Free Samples |
| SN74LVC1G17YEAR | ACTIVE | -40 to 85 | 0.23 1KU | WCSP (YEA) 5 | | 3000 | <input type="checkbox"/> | Request Free Samples |
| SN74LVC1G17YEPR | ACTIVE | -40 to 85 | 0.23 1KU | WCSP (YEP) 5 | | 3000 | <input type="checkbox"/> | Purchase Samples |
| SN74LVC1G17YZAR | ACTIVE | -40 to 85 | 0.23 1KU | WCSP (YZA) 5 | | 3000 | <input type="checkbox"/> | Request Free Samples |
| SN74LVC1G17YZPR | ACTIVE | -40 to 85 | 0.23 1KU | WCSP (YZP) 5 | | 3000 | <input type="checkbox"/> | Request Free Samples |

Inventory

| | TI Inventory Status | | | Reported Distributor Inventory | | | |
|-------------------|--------------------------------|------------------------|-----------|--------------------------------|-----------------------------------|----------|----------------------|
| SN74LVC1G17DBVR | As of 9:07 AM GMT, 29 Nov 2005 | | | As of 9:07 AM GMT, 29 Nov 2005 | | | |
| | In Stock | In Progress QTY Date | Lead Time | Region | Company | In Stock | Purchase |
| | 0* | >10k 9 Jan | 6 Weeks | Americas | Newark InOne | >1k | <input type="text"/> |
| | | | | Europe | Avnet-SILICA | >1k | <input type="text"/> |
| | | | | | Rutronik | >1k | <input type="text"/> |
| SN74LVC1G17DBVRE4 | As of 9:07 AM GMT, 29 Nov 2005 | | | As of 9:07 AM GMT, 29 Nov 2005 | | | |
| | In Stock | In Progress QTY Date | Lead Time | Region | Company | In Stock | Purchase |
| | 0* | >10k 9 Jan | 6 Weeks | None Reported | View Distributors | | |
| SN74LVC1G17DBVRG4 | As of 9:07 AM GMT, 29 Nov 2005 | | | As of 9:07 AM GMT, 29 Nov 2005 | | | |

[View all Distributors](#)

[Choose a Region](#)



| | In Stock | In Progress QTY Date | Lead Time | Region | Company | In Stock | Purchase |
|-------------------|--------------------------------|------------------------|-----------|--------------------------------|-----------------------------------|----------|----------|
| | 0* | >10k 9 Jan | 6 Weeks | None Reported | View Distributors | | |
| SN74LVC1G17DBVT | As of 9:07 AM GMT, 29 Nov 2005 | | | As of 9:07 AM GMT, 29 Nov 2005 | | | |
| | In Stock | In Progress QTY Date | Lead Time | Region | Company | In Stock | Purchase |
| | >10k* | >10k 31 Jan | 6 Weeks | Asia | P&S | 14 | |
| | | | | Europe | Avnet-SILICA | 1k | |
| SN74LVC1G17DBVTE4 | As of 9:07 AM GMT, 29 Nov 2005 | | | As of 9:07 AM GMT, 29 Nov 2005 | | | |
| | In Stock | In Progress QTY Date | Lead Time | Region | Company | In Stock | Purchase |
| | >10k* | >10k 31 Jan | 6 Weeks | None Reported | View Distributors | | |
| SN74LVC1G17DCKR | As of 9:07 AM GMT, 29 Nov 2005 | | | As of 9:07 AM GMT, 29 Nov 2005 | | | |
| | In Stock | In Progress QTY Date | Lead Time | Region | Company | In Stock | Purchase |
| | 0* | >10k 12 Jan | 6 Weeks | Americas | DigiKey | 374 | |
| | | | | Asia | P&S | >1k | |
| SN74LVC1G17DCKRE4 | As of 9:07 AM GMT, 29 Nov 2005 | | | As of 9:07 AM GMT, 29 Nov 2005 | | | |
| | In Stock | In Progress QTY Date | Lead Time | Region | Company | In Stock | Purchase |
| | 0* | >10k 12 Jan | 6 Weeks | None Reported | View Distributors | | |
| SN74LVC1G17DCKRG4 | As of 9:07 AM GMT, 29 Nov 2005 | | | As of 9:07 AM GMT, 29 Nov 2005 | | | |
| | In Stock | In Progress QTY Date | Lead Time | Region | Company | In Stock | Purchase |
| | 0* | >10k 23 Jan | 8 Weeks | None Reported | View Distributors | | |
| SN74LVC1G17DCKT | As of 9:07 AM GMT, 29 Nov 2005 | | | As of 9:07 AM GMT, 29 Nov 2005 | | | |
| | In Stock | In Progress QTY Date | Lead Time | Region | Company | In Stock | Purchase |
| | 0* | >10k 7 Feb | 10 Weeks | Americas | Avnet | 750 | |
| | | | | | Newark InOne | 250 | |
| | | | | Asia | P&S | 232 | |
| SN74LVC1G17DCKTE4 | As of 9:07 AM GMT, 29 Nov 2005 | | | As of 9:07 AM GMT, 29 Nov 2005 | | | |
| | In Stock | In Progress QTY Date | Lead Time | Region | Company | In Stock | Purchase |
| | 0* | >10k 7 Feb | 10 Weeks | None Reported | View Distributors | | |
| SN74LVC1G17DRLR | As of 9:07 AM GMT, 29 Nov 2005 | | | As of 9:07 AM GMT, 29 Nov 2005 | | | |
| | In Stock | In Progress QTY Date | Lead Time | Region | Company | In Stock | Purchase |
| | 0* | 8000 12 Dec | 4 Weeks | Americas | DigiKey | >1k | |
| | | >10k 4 Jan | | | | | |
| SN74LVC1G17DRLRG4 | As of 9:07 AM GMT, 29 Nov 2005 | | | As of 9:07 AM GMT, 29 Nov 2005 | | | |
| | In Stock | In Progress QTY Date | Lead Time | Region | Company | In Stock | Purchase |
| | 0* | 8000 12 Dec | 4 Weeks | None Reported | View Distributors | | |
| | | >10k 4 Jan | | | | | |
| SN74LVC1G17YEAR | As of 9:07 AM GMT, 29 Nov 2005 | | | As of 9:07 AM GMT, 29 Nov 2005 | | | |
| | In Stock | In Progress QTY Date | Lead Time | Region | Company | In Stock | Purchase |
| | 0* | >10k 5 Jan | 6 Weeks | Americas | DigiKey | >1k | |

| SN74LVC1G17YEPR | As of 9:07 AM GMT, 29 Nov 2005 | | | As of 9:07 AM GMT, 29 Nov 2005 | | | |
|------------------------|--------------------------------|------------------------|-----------|--------------------------------|-----------------------------------|----------|----------|
| | In Stock | In Progress QTY Date | Lead Time | Region | Company | In Stock | Purchase |
| | 0* | | 10 Weeks | None Reported | View Distributors | | |
| SN74LVC1G17YZAR | As of 9:07 AM GMT, 29 Nov 2005 | | | As of 9:07 AM GMT, 29 Nov 2005 | | | |
| | In Stock | In Progress QTY Date | Lead Time | Region | Company | In Stock | Purchase |
| | 0* | >10k 17 Jan | 7 Weeks | Americas | DigiKey | >1k | |
| SN74LVC1G17YZPR | As of 9:07 AM GMT, 29 Nov 2005 | | | As of 9:07 AM GMT, 29 Nov 2005 | | | |
| | In Stock | In Progress QTY Date | Lead Time | Region | Company | In Stock | Purchase |
| | 0* | | 10 Weeks | Americas | DigiKey | >1k | |

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Quality & Lead (Pb)-Free Data

| <input type="checkbox"/> | Product Content | | | | | MTBF/FIT Rate |
|--|-------------------------|------------------|------------------------|----------------------|----------------------|---------------|
| Device | Eco Plan* | Lead/Ball Finish | MSL Rating/Peak Reflow | Details | Details | |
| SN74LVC1G17DBVR <input type="checkbox"/> | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | View | View | |
| SN74LVC1G17DBVRE4 <input type="checkbox"/> | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | View | View | |
| SN74LVC1G17DBVRG4 <input type="checkbox"/> | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | View | View | |
| SN74LVC1G17DBVT <input type="checkbox"/> | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | View | View | |
| SN74LVC1G17DBVTE4 <input type="checkbox"/> | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | View | View | |
| SN74LVC1G17DCKR <input type="checkbox"/> | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | View | View | |
| SN74LVC1G17DCKRE4 <input type="checkbox"/> | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | View | View | |
| SN74LVC1G17DCKRG4 <input type="checkbox"/> | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | View | View | |
| SN74LVC1G17DCKT <input type="checkbox"/> | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | View | View | |
| SN74LVC1G17DCKTE4 <input type="checkbox"/> | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | View | View | |
| SN74LVC1G17DRLR <input type="checkbox"/> | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | View | View | |
| SN74LVC1G17DRLRG4 <input type="checkbox"/> | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | View | View | |
| SN74LVC1G17YEAR | TBD | SNPB | Level-1-260C-UNLIM | View | View | |
| SN74LVC1G17YEPR | TBD | SNPB | Level-1-260C-UNLIM | View | View | |
| SN74LVC1G17YZAR <input type="checkbox"/> | Pb-Free (RoHS) | SNAGCU | Level-1-260C-UNLIM | View | View | |
| SN74LVC1G17YZPR <input type="checkbox"/> | Pb-Free (RoHS) | SNAGCU | Level-1-260C-UNLIM | View | View | |

* The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please click on the Product Content Details "View" link in the table above for the latest availability information and additional product content details.

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Technical Documents

Datasheets

SN74LVC1G17 (Rev. N) (sn74lvc1g17.pdf, 486 KB)

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Application Notes

08 Jul 2004 [Abstract](#)

Selecting the Right Level Translation Solution (Rev. A) (scea035a.htm, 9 KB)

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Use of the CMOS Unbuffered Inverter in Oscillator Circuits (szza043.htm, 9 KB)

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Understanding and Interpreting Standard-Logic Data Sheets (Rev. B) (szza036b.htm, 8 KB)

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Texas Instruments Little Logic Application Report (scea029.htm, 9 KB)

01 Nov 2002 [Abstract](#)

TI IBIS File Creation, Validation, and Distribution Processes (szza034.htm, 9 KB)

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16-Bit Widebus Logic Families in 56-Ball, 0.65-mm Pitch Very Thin Fine-Pitch BGA (Rev. B) (szza029b.htm, 9 KB)

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Power-Up 3-State (PUS) Circuits in TI Standard Logic Devices (szza033.htm, 9 KB)

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Selecting the Right Texas Instruments Signal Switch (szza030.htm, 9 KB)

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Implications of Slow or Floating CMOS Inputs (Rev. C) (scba004c.htm, 9 KB)

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Bus-Interface Devices With Output-Damping Resistors Or Reduced-Drive Outputs (Rev. A) (scba012a.htm, 9 KB)

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CMOS Power Consumption and CPD Calculation (Rev. B) (scaa035b.htm, 9 KB)

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User Guides

Signal Switch Data Book (Rev. A) (scdd003a.pdf, 19732 KB)

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LOGIC Pocket Data Book (scyd013.pdf, 4835 KB)

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Simulation Models

IBIS Model

IBIS Model of SN74LVC1G17 (Rev. A) (scem299a.ibs, 243 KB)

14 Aug 2003 [ibis / zip](#)

More Literature

Logic Selection Guide 2005 (Rev. X) (sdyu001x.pdf, 6909 KB)

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Wireless Infrastructure Solutions Guide (2Q2005) (Rev. E) (sstc001e.pdf, 734 KB)

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SN74LVC1G3157 and SNS74LVC2G53 SPDT Analog Switches (scyb014.pdf, 65 KB)

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Standard Linear & Logic for PCs, Servers & Motherboards (scyb005.pdf, 3997 KB)

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STANDARD LINEAR AND LOGIC FOR DVD/VCD PLAYERS (scym001.pdf, 5872 KB)

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Military Low Voltage Solutions (sgyn139.pdf, 103 KB)

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Low-Voltage Logic (LVC) Designer's Guide (scba010.htm, 9 KB)

01 Sep 1996 [Abstract](#)

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